

**AMENDMENTS TO THE CLAIMS**

1. (Original) A method for producing an organic thin-film device comprising the steps of (a) heating and/or pressing a transfer material having an organic thin-film layer formed on a temporary support and a first laminate comprising a substrate and at least a transparent conductive layer or a rear-surface electrode formed on said substrate, which are overlapped each other such that said organic thin-film layer of said transfer material faces a receiving surface of said first laminate, thereby forming a laminate structure; (b) peeling said temporary support from said laminate structure to transfer said organic thin-film layer to said receiving surface of said first laminate; and (c) bonding a second laminate comprising a substrate and at least a rear-surface electrode or a transparent conductive layer formed on said substrate to said organic thin-film layer transferred onto said first laminate.

2. (Original) The method of claim 1, wherein said step (a) comprises heating and pressing.

3. (Original) The method of claim 1 or 2, wherein the heating is carried out by a heating means selected from the group consisting of a laminator, an infrared heater and a roller heater.

4. (Currently Amended) The method of ~~any one of claims 1 to 3~~ claim 1, wherein said transfer material is formed by a wet method.

5. (Currently Amended) The method of ~~any one of claims 1 to 4~~ claim 1, wherein said second laminate has an organic thin-film layer formed on said rear-surface electrode or said

transparent conductive layer.

6. (Currently Amended) The method of ~~any one of claims 1 to 5~~ claim 1, wherein said first laminate and said second laminate respectively have a thermal expansion coefficient of 20 ppm/°C or less.

7. (Currently Amended) The method of ~~any one of claims 1 to 6~~ claim 1, wherein said organic thin-film layer contains at least a light-emitting, organic compound or a carrier-transporting, organic compound.

8. (Currently Amended) The method of ~~any one of claims 1 to 7~~ claim 1, wherein a hole-transporting, organic thin-film layer, a light-emitting, organic thin-film layer and an electron-transporting, organic thin-film layer are successively transferred.

9. (Currently Amended) The method of ~~any one of claims 1 to 8~~ claim 1, wherein at least one of said first substrate and said second substrate is provided with a transparent conductive layer.

10. (Currently Amended) The method of ~~any one of claims 1 to 9~~ claim 1, wherein at least one of said temporary support and said substrate is in the form of a continuous web.

11. (Currently Amended) The method of ~~any one of claims 1 to 10~~ claim 1, wherein said substrate is made of at least one material selected from the group consisting of polyimides; polyesters; polycarbonates; polyether sulfone; metal foils such as aluminum foil, copper foil, stainless steel foil, gold foil, silver foil; plastic sheets of liquid crystal polymers; fluorine-containing polymers such as poly(chlorotrifluoroethylene), Teflon, polytetrafluoroethylene-polyethylene copolymers.

12. (Currently Amended) An organic thin-film device produced by the method of ~~any one of claims 1 to 11~~ claim 1.

13. (Original) A method for producing an organic electroluminescent device comprising the steps of (a) heating and/or pressing a transfer material having an organic thin-film layer formed on a temporary support and a first laminate comprising a substrate and at least a transparent conductive layer or a rear-surface electrode formed on said substrate, which are overlapped each other such that said organic thin-film layer of said transfer material faces a receiving surface of said first laminate, thereby forming a laminate structure; (b) peeling said temporary support from said laminate structure to transfer said organic thin-film layer to said receiving surface of said first laminate; and (c) bonding a second laminate comprising a substrate and at least a rear-surface electrode or a transparent conductive layer formed on said substrate to said organic thin-film layer transferred onto said first laminate.

14. (Original) The method of claim 13, wherein said step (a) comprises heating and pressing.

15. (Original) The method of claim 13 or 14, wherein a heating means is selected from the group consisting of a laminator, an infrared heater and a roller heater.

16. (Currently Amended) The method of ~~any one of claims 13 to 15~~ claim 13, wherein said second laminate has an organic thin-film layer formed on said rear-surface electrode or said transparent conductive layer.